

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

First Named  
Inventor : Zine-Eddine Boutaghou et al.  
  
Appln. No. :  
  
Filed : HEREWITH  
  
For : LOCALIZED HEATING ELEMENT FOR  
A SUSPENSION ASSEMBLY  
  
Docket No.: S01.12-0992

Group Art Unit:  
  
Examiner:

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

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21 DAY OF August, 2003  
  
PATENT ATTORNEY

Sir:

The patents or publications listed on the enclosed PTO  
Form-1449 are submitted pursuant to 37 C.F.R. § 1.97. Copies of  
the non-U.S. patents or publications cited are enclosed.

The Director is authorized to charge any fee deficiency  
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Respectfully submitted,

WESTMAN, CHAMPLIN & KELLY, P.A.

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FORM PTO-1449	Atty. Docket No.: S01.12-0992	Appl. No.:
LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT	First Named Inventor:	
	Zine-Eddine Boutaghoul	
	Filing Date	Group Art:
	HEREWITH	

## U.S. PATENT DOCUMENTS

Examiner Initial	Document No.	Date	Name	Class	Sub Class	Filing Date If Appropriate
AA	4,871,899	10/3/89	DeFrenne	219	233	
AB	5,699,212	12/16/97	Erpelding et al.	360	104	
AC	5,757,585	5/26/98	Aoyagi et al.	360	104	
AD	5,796,549	8/18/98	Sedbrook et al.	360	103	
AE	5,835,306	11/10/98	Bennin	360	104	
AF	5,889,636	3/10/99	Arya et al.	360	104	
AG	6,078,473	6/20/00	Crane et al.	360	104	
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AK	2002/0057531	5/16/02	Segar et al.	360	234.5	Nov. 13, 2001
AL	2002/0113115	8/22/02	Satoh et al.	228	41	Feb. 13, 2002

## FOREIGN PATENT DOCUMENTS

	Document No.	Date	Country	Class	Sub Class	Translation Yes No
AM						
AN						
AO						

## OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)

AP	Cheng et al., "Localized Silicon Fusion and Eutectic Bonding for MEMS Fabrication and Packaging", 2000 IEEE Journal of Microelectromechanical Systems, Vol. 9, No. 1, pp. 3-8, March 2000.
AQ	
AR	

EXAMINER:

DATE CONSIDERED:

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.